

S-8473 Series

Rev.2.1 00

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WIRELESS POWER RECEIVER CONTROL IC WITH CHARGE FUNCTION

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The S-8473 Series is Wireless Power Receiver Control IC, which is configured with an overvoltage detection circuit, a charge current control circuit, a VBAT voltage detection circuit, a UVLO circuit, high temperature / low temperature detection circuit, etc. This IC has a charge function to a small lithium-ion rechargeable battery.

Features

 Power supply voltage: Current consumption during charge operation: VBAT pin current consumption during power-or UVLO detection voltage: 	lown:	V _{DD} = 2.2 V to 5.0 V I _{SS1} = 250 μA typ. I _{PDN} = 1.0 μA max. V _{UVLO} = 2.0 V typ.	
• Charge function to a small lithium-ion recharge	eable batte	ery	
Charge current:	I _{LIM} = 33 ι	mA typ.	
Precharge current:	$I_{PRE} = 3.3$	3 mA typ.	
Precharge completion voltage:	2.4 V to 3	3.4 V (50 mV step)	
Charge completion voltage:	4.0 V to 4	.5 V (50 mV step)	
Recharge start voltage:	3.6 V to 4	.45 V*1	
Short-circuit detection voltage:	1.5 V to 2	2.0 V (50 mV step)	
Charge timer function:	The charg	ge operation stops after the elap	ose of 4.0 hours. (C_{CT} = 4.7 nF)
	The time	is settable by connecting an ext	ternal capacitor to the CT pin.
• High temperature / low temperature protection	function:	Available by connecting a ther	mistor to the TH pin.
 Status display function: 		Available by connecting an ext	ernal LED to the STATUS pin.
		During charge operation:	Lighting
		During charge operation stop:	Lights-out
		During error detection:	Blinking
 Operation temperature range: 		Ta = -40°C to +85°C	
 Lead-free (Sn 100%), halogen-free 			

*1. Recharge start voltage = charge completion voltage – charge hysteresis voltage (The charge hysteresis voltage can be selected from a range of 0.05 V to 0. 40 V in 50 mV step.)

Applications

- Device for wireless power
- Small-sized wireless charge system

Package

• SNT-8A

Block Diagram





Figure 1

Product Name Structure

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "3. Product name list".

2. Package

 Table 1
 Package Drawing Codes

Package Name	Dimension	Таре	Reel	Land
SNT-8A	PH008-A-P-SD	PH008-A-C-SD	PH008-A-R-SD	PH008-A-L-SD

3. Product name list

Table 2						
	Charge	Charge	Recharge	Precharge	Short-circuit	
Product Name	Current	Completion Voltage	Start Voltage	Completion Voltage	Detection Voltage	
	[I _{LIM}]	[V _{END}]	[V _{RECHG}]	[V _{PREH}]	[V _{SHT}]	
S-8473AAA-I8T1U	33 mA	4.2 V	4.0 V	3.0 V	2.0 V	

Remark Please contact our sales representatives for products other than the above.

Pin Configuration

1. SNT-8A



Figure 2

Table 3				
Pin No.	Symbol	Description		
1	VDD	Power supply voltage pin		
2	VBAT	Connection pin of battery for charging		
3	TH	Thermistor connection pin		
4	STATUS	Output pin for status display		
5	СТ	Connection pin of capacitor for charge timer setting		
6	WAKEUP	WAKEUP input pin		
7	VSS	GND pin		
8	OUT	FET gate drive pin for resonance		

Absolute Maximum Ratings

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Table 4

			(Ta = +25°C unless otherwise	specified)
Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit
Input voltage between VDD pin and VSS pin	Vdd	VDD	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 7.0$	V
Input voltage between VBAT pin and VSS pin	Vvbat	VBAT	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 7.0$	V
Input pin voltage	VIN	TH, CT, WAKEUP	$V_{\text{SS}}-0.3$ to $V_{\text{DD}}+0.3$	V
Output pin voltage	Vout	STATUS, OUT	$V_{\text{SS}}-0.3$ to $V_{\text{DD}}+0.3$	V
Power dissipation	PD	—	450 ^{*1}	mW
Operation ambient temperature	T _{opr}	—	-40 to +85	°C
Storage temperature	T _{stg}	-	-40 to +125	°C

*1. When mounted on board

[Mounted board]

- (1) Board size: $114.3 \text{ mm} \times 76.2 \text{ mm} \times t1.6 \text{ mm}$
- (2) Board name: JEDEC STANDARD51-7
- Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.



Figure 3 Power Dissipation of Package (When Mounted on Board)

Electrical Characteristics

Table 5

$(V_{DD} = V_{BAT} = 4.5 \text{ V}, \text{ Ta} = +25^{\circ}\text{C}$ unless otherwise specified)						
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply voltage	V _{DD}	_	2.2	_	5.0	V
Current consumption				050	400	
during charge operation	ISS1	$V_{DD} = V_{BAT} = V_{WAKEUP} = V_{END} - 0.1 V$	_	250	400	μA
VBAT pin current consumption					4.0	•
during power-down	IPDN	$V_{WAKEUP} = 0 V, VDD pin = open$	_	0.1	1.0	μA
VDD pin current				450		•
during charge operation completion	IEND1	$V_{WAKEUP} = V_{DD}, V_{BAT} = V_{END} + 0.1 V$	_	150	300	μA
VBAT pin current					4.0	•
during charge operation completion	IEND2	$V_{WAKEUP} = V_{DD}, V_{BAT} = V_{END} + 0.1 V$	_	1.0	4.0	μΑ
UVLO detection voltage	V _{UVLO-}	_	1.9	2.0	2.1	V
UVLO release voltage	VUVLO+	_	2.0	2.1	2.2	V
OUT pin sink current	IOUTN	Vout = 0.5 V. VDD = VEND + 0.4 V	1.4	_	_	mA
OUT pin source current	OUTP	$V_{OUT} = V_{DD} - 0.5 V$, $V_{DD} = V_{END} + 0.2 V$	_	_	-1.4	mA
WAKEUP pin input voltage "H"	Vsh	_	15	_	_	V
WAKEUP pin input voltage "I "	Vei	_	_	_	04	v
WAKELIP nin input current "H"	leu			35	70	ν
WAKEUP pin input current "I "			0.1	- 55	01	μΑ
WAKEUP pin input disconnection	ISL	VWAREOP - 0 V	-0.1		0.1	μΛ
delay time	twul	-	40	85	130	ms
VPAT pip Deb driver on registence	Dava			4.0	6.0	0
VBAT pin Peh driver lookege ourrent	RONP	VDD = VEND = 0.1 V	_	4.0	0.0	
	ILEAKP			-	1.0	μΑ
	ILIM	$V_{DD} = V_{END} - 0.1 V$	29	33	3/	mA
Precharge current	IPRE	$V_{DD} = V_{END} + 0.4 V$	2.9	3.3	3.7	mA
Precharge completion voltage	VPREH	_	Vpreh × 0.99	VPREH	V _{PREH} × 1.01	V
Charge completion voltage	Vend	_	$V_{\text{END}} imes 0.99$	Vend	$V_{END} \times 1.01$	V
Overvoltage detection voltage	Vovp	$V_{OVP} = V_{END} + 0.3 V$	$V_{OVP} \times 0.98$	Vovp	V _{OVP} × 1.02	V
Overvoltage release voltage	Vovpr	V _{OVPR} = V _{END} + 0.2 V	$V_{OVPR} \times 0.98$	VOVPR	V _{OVPR} × 1.02	V
Recharge start voltage	VRECHG	_	$V_{\text{RECHG}} imes 0.99$	VRECHG	$V_{\text{RECHG}} \times 1.01$	V
Short-circuit detection voltage	VSHT	_	$V_{SHT} imes 0.98$	V _{SHT}	V _{SHT} × 1.02	V
Short-circuit release voltage	Vsнтн	V _{SHTH} = V _{SHT} + 0.1 V	V _{SHTH} × 0.98	VSHTH	V _{SHTH} × 1.02	V
STATUS pin Pch driver on resistance	RONPST	_	_	20	30	Ω
STATUS pin leakage current	ISTPL	V _{STATUS} = 0 V, V _{BAT} = 0 V	_	0.1	1.0	μA
TH pin internal resistance	RLIN	_	72.79	80.88	88.97	kΩ
TH pin high temperature protection detection voltage	VTSDH	_	0.375	0.400	0.425	V
TH pin high temperature protection release voltage	Vtsrh	-	0.462	0.487	0.512	V
TH pin low temperature protection detection voltage	VTSDL	-	0.950	0.975	1.000	V
TH pin low temperature protection release voltage	VTSRL	-	0.900	0.925	0.950	V
Oscillation frequency for charge timer	fosc	C _{CT} = 4.7 nF	32.5	36.4	40.0	Hz
STATUS pin blinking cvcle	tsw	С _{ст} = 4.7 nF	0.79	0.88	0.97	s
STATUS pin blinking duty	Dsw	_	40	50	60	%

Test Circuit



Figure 4

Operation

Remark Refer to "■ Standard Circuit".

1. Basic operation

1.1 Power reception

- (1) When the WAKEUP pin input voltage is the WAKEUP pin input voltage "H" (V_{SH}) or higher and the power supply voltage (V_{DD}) is the UVLO release voltage (V_{UVLO+}) or higher, the operations of all internal circuits are started. V_{DD} ("H") is output from the OUT pin until V_{DD} reaches the overvoltage detection voltage (V_{OVP}).
- (2) The charge operation to a lithium-ion rechargeable battery is started. Refer to "1. 2 Charge operation" for details.
- (3) The WAKEUP pin input voltage is disconnected, and then V_{DD} decreases gradually.
- (4) When V_{DD} is the UVLO detection voltage (V_{UVLO}) or lower, the IC changes to a UVLO detection status. In the UVLO detection status, the operations of all internal circuits other than the UVLO circuit are stopped, V_{SS} ("L") is output from the OUT pin, and the STATUS pin changes to "High-Z".
- (5) The WAKEUP pin input voltage decreases to the WAKEUP pin input voltage "L" (V_{SL}) or lower, after the elapse of the WAKEUP pin input disconnection delay time (t_{WUL}), the IC changes to a power-down status. In the power-down status, the operations of all internal circuits are stopped, reducing the current consumption significantly. V_{SS} is output from the OUT pin and the STATUS pin changes to "High-Z".



*1. If the time that the WAKEUP pin input voltage decreases to V_{SL} or lower is under t_{WUL}, the IC continues the operation.

Figure 5

Remark Between V_{SL} and V_{SH} or V_{UVLO+} and V_{UVLO-}, there is a hysteresis width for avoiding malfunctions due to generation of noise etc. in the input voltage, respectively.

1.2 Charge operation

Power supply voltage (V_{DD}) is output from the OUT pin until V_{DD} reaches V_{OVP} . When V_{DD} exceeds the VBAT pin voltage (V_{BAT}) + 0.6 V typ., the charge operation is started.

(1) Precharge operation

When V_{BAT} is the short-circuit release voltage (V_{SHTH}) or higher and lower than the precharge completion voltage (V_{PREH}), the precharge operation is performed. The charge current during the precharge operation changes to the precharge current (I_{PRE}). During the precharge operation, V_{SS} is output from the OUT pin when V_{DD} is V_{OVP} or higher, and V_{DD} is output from the OUT pin when V_{DD} is the overvoltage release voltage (V_{OVPR}) or lower.

(2) Normal charge operation

When V_{BAT} is V_{PREH} or higher and lower than the charge completion voltage (V_{END}), the normal charge operation is performed.

In the normal charge operation, a Pch driver connected between the VDD pin and the VBAT pin is turned on, and a current flows from the VDD pin to the VBAT pin. V_{SS} is output from the OUT pin when the charge current is the charge current threshold (I_{LIM}) or higher, and V_{DD} is output from the OUT pin when the charge current is I_{LIM} or lower. When V_{BAT} is V_{END} or higher, I_{LIM} decreases and the IC continues the charge operation. Each time V_{BAT} reaches V_{END}, I_{LIM} decreases in four steps of I_{LIM} × 3/4, I_{LIM} × 1/2, I_{LIM} × 1/4 and I_{PRE}.

(3) Charge operation completion

At the time when V_{BAT} reaches V_{END} after I_{LIM} changes to I_{PRE} , the charge operation is completed.

A Pch driver is turned off when the charge operation is completed, V_{SS} is output from the OUT pin when V_{DD} is V_{OVP} or higher, and V_{DD} is output from the OUT pin when V_{DD} is V_{OVPR} or lower.



Remark When V_{BAT} decreases to the recharge start voltage (V_{RECHG}) after the charge operation is completed, the charge operation is resumed.

1.3 Short-circuit detection

In the S-8473 Series, the charge operation is stopped when V_{BAT} decreases due to a battery abnormality, a short-circuit, etc. The charge operation is stopped when V_{BAT} is short-circuit detection voltage (V_{SHT}) or lower, "H" and "High-Z" are output from the STATUS pin, and the operation is repeated with the STATUS pin blinking cycle (t_{SW}). Also, V_{SS} is output from the OUT pin when V_{DD} is V_{OVP} or higher, and V_{DD} is output from the OUT pin when V_{DD} is V_{OVPR} or lower. When V_{BAT} increases to the short-circuit release voltage (V_{SHT}) or higher, the charge operation is started.

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2. Charge timer function

In the S-8473 Series, a charge timer can be set by connecting an external capacitor to the CT pin. The precharge timer which sets the time from the charge operation start to the precharge operation completion and the charge completion timer which sets the time from the charge operation start to the charge operation completion are prepared. The charge operation is stopped due to a time-out of the charge timer, the IC changes to a charge time-out status, "H" and "High-Z" are output from the STATUS pin, and the operation is repeated with t_{SW} . Also, V_{SS} is output from the OUT pin when V_{DD} is V_{OVP} or higher, and V_{DD} is output from the OUT pin when V_{DD} is V_{OVPR} or lower.

By setting the IC power-down status or decreasing V_{DD} to V_{UVLO-} or lower, the charge time-out status can be reset. Depending on the oscillation frequency for charge timer (fosc) which is determined by the capacitance of the CT pin, the precharge timer or the charge completion timer can be set by using the following equation.

Precharge timer: $\frac{1}{f_{OSC} [Hz]} \times 2^{16}$ [s]

Charge completion timer: $\frac{1}{f_{OSC} [Hz]} \times 2^{19} [s]$

For example, when C_{CT} = 4.7 nF, settings of the precharge timer and the charge completion timer are approximately 30 minutes and approximately 4.0 hours, respectively. fosc is calculated by the following equation.

$$f_{OSC}$$
 [Hz] = $\frac{170.77}{C_{CT}$ [nF]

Select the external capacitor (C_{CT}) in the range of 0.22 nF to 47 nF, and connect it between the CT pin and the VSS pin.

3. High temperature / low temperature protection function

By connecting an external thermistor to the TH pin, a temperature abnormal status can be prevented.

3.1 High temperature protection function

When the temperature of external components increases and the resistance of thermistor decreases to the resistance calculated by equation (1) (R_{TH}), the status changes to a high temperature protection status. In the high temperature protection status, the charge operation is resumed when R_{TH} increases to the resistance calculated by equation (2).

(1)
$$\mathsf{R}_{\mathsf{TH}} [\mathbf{k}\Omega] = \frac{\mathsf{R}_{\mathsf{LIN}}[\mathbf{k}\Omega] \times \mathsf{V}_{\mathsf{TSDH}}[\mathsf{V}]}{(1.2 - \mathsf{V}_{\mathsf{TSDH}}[\mathsf{V}])}$$
 (2) $\mathsf{R}_{\mathsf{TH}} [\mathbf{k}\Omega] = \frac{\mathsf{R}_{\mathsf{LIN}}[\mathbf{k}\Omega] \times \mathsf{V}_{\mathsf{TSRH}}[\mathsf{V}]}{(1.2 - \mathsf{V}_{\mathsf{TSRH}}[\mathsf{V}])}$

3.2 Low temperature protection function

When the temperature of external components decreases and the resistance of R_{TH} increases to the resistance calculated by equation (3), the status changes to a low temperature protection status. In the low temperature protection status, the charge operation is resumed when R_{TH} decreases to the resistance calculated by equation (4).

(3)
$$R_{TH} [k\Omega] = \frac{R_{LIN} [k\Omega] \times V_{TSDL} [V]}{(1.2 - V_{TSDL} [V])}$$
 (4) $R_{TH} [k\Omega] = \frac{R_{LIN} [k\Omega] \times V_{TSRL} [V]}{(1.2 - V_{TSRL} [V])}$

In the high temperature / low temperature protection status, the charge function and the charge timer function are stopped, and the CT pin becomes V_{SS} potential. However, the internal other circuits operate during the period unlike the power-down status, so caution should be exercised.

Connect a thermistor between the TH pin and the VSS pin. An NTC thermistor of R = $100 \text{ k}\Omega$ (R₂₅) at Ta = $+25^{\circ}$ C is recommended. For example, if an NTC thermistor of R₂₅ and B_{25/50} (B constant (25° C/ 50° C)) = 4250 K is used, the high temperature protection function begins to operate at approximately $+45^{\circ}$ C, and the low temperature protection function begins to operate at approximately -45° C, and the low temperature protection function begins to operate at approximately -45° C.

When not using the high temperature / low temperature protection function, connect a resistor of 100 kΩ.

4. Status display function

The S-8473 Series can display the operation status by connecting an external LED to the STATUS pin.

During the charge operation, a Pch driver of the STATUS pin is turned on, "H" is output from the STATUS pin, and the external LED is lighted on.

During the charge operation stop, the Pch driver of the STATUS pin is turned off, the STATUS pin changes to "High-Z", and the external LED is lighted off.

During the error detection, the Pch driver of the STATUS pin is turned on and off repeatedly. Also, "H" and "High-Z" are output from the STATUS pin, the operation is repeated with tsw, and the external LED is blinked. When not using the status display function, set the STATUS pin open.

Table 6					
Sta	STATUS Pin	External LED			
During charge energian	Precharge operation	"[]"	Lighting		
During charge operation	Normal charge operation	п			
During charge energies aton	Power-down status	"Lliah 7"	Lights-out		
During charge operation stop	Charge operation completion	nigh-z			
Dunin n. anna data atia n	Short-circuit detection		Blinking		
During error detection	Charge time-out status	"H" ↔ "Hign-Z"			
High temperature / low temperature protection status		Maintaining*1	Maintaining*1		

*1. The status before the high temperature / low temperature protection function operates is maintained.

Standard Circuit



Figure 7

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

Precautions

- Mount an external resistor, a capacitor, a diode, an FET, etc. as close as possible to the IC so as to make the single GND.
- When the wiring impedance is high, the operation may be unstable due to the resonance circuit or the noise caused by switching of the output pin, so perform thorough evaluation using the actual application when designing.
- The power dissipation of the IC greatly varies depending on the size and material of the board to be mounted. Perform thorough evaluation using the actual application when designing.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
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Characteristics (Typical Data)

- 1. Current consumption
 - 1.1 Iss1 vs. Ta







2. Precharge current, charge current threshold

2.1 IPRE VS. Ta













3. UVLO detection / release voltage, precharge completion voltage, charge completion voltage, overvoltage detection / release voltage, recharge start voltage, short-circuit detection / release voltage





























V_{OVPR} = 4.4 V







WIRELESS POWER RECEIVER CONTROL IC WITH CHARGE FUNCTION S-8473 Series





4. Output current, Pch driver on resistance for charging, Pch driver on resistance for STATUS pin



5. TH pin internal resistance, TH pin high temperature protection detection / release voltage, TH pin low temperature protection detection / release voltage



















5.6 VTSRH – Ta







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6. Oscillation frequency for charge timer, STATUS pin blinking cycle



6.3 t_{SW} vs. V_{DD}











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